

QLSP29XDX-XXX (5050 30D LEDs)





#### **Product Outline:**

QLSP29XDX-XXX series are color LEDs bring high performance and quality of light to wide range of lighting application. The lighting application such as cation light, decoration light, signal, specific industrial and commercial lighting.

### Features:

- High brightness output @ 50mA / 150mA
- Package Dimension = 5.0mmX5.4mmX5.2mm
- View angle 30-40 degree
- ESD protection up to 3KV
- RoHS compliant
- Custom Bin available upon special request

### **Application:**

- Architecture Lighting
- Garden Lighting
- Warming lamp
- Indoor Lighting
- Outdoor Lighting

# **Compliance and Certification:**

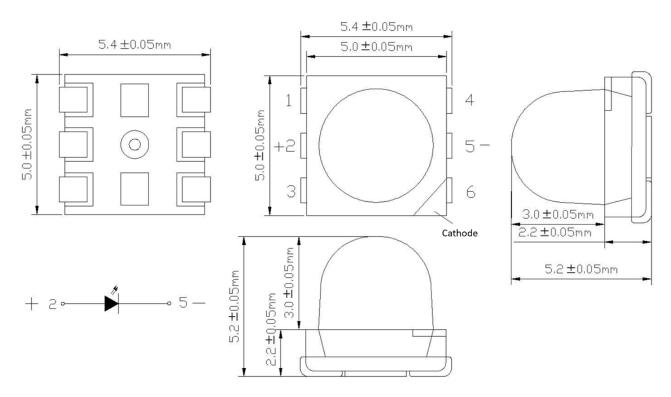




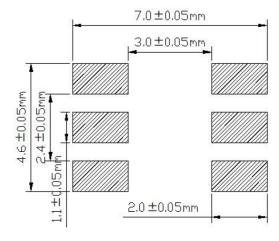




# **Mechanical Property:** (Dimension)



# **Recommended Solder footprint:**



- \* All dimensions are in millimeters.
- \* The LEDs is designed to be reflow soldered on to a PCB. IF dip soldered that QL cannot guarantee its reliability.
- \* Reflow soldering must not be performed more than twice.





**Electrical / Optical Characteristic** 

(T=25 °C)

| Product    | Color | I <sub>F</sub> (mA) | V <sub>F</sub> (V) |     | V <sub>F</sub> (V) |       | CCT/ Wavelength |  | us Flux<br>ncd) |
|------------|-------|---------------------|--------------------|-----|--------------------|-------|-----------------|--|-----------------|
|            |       |                     | Тур.               | max | K/nm               | Min   | typ.            |  |                 |
| QLSP29WXDH | White | 150                 | 3.2                | 3.5 | 2700~6500K         | 50 lm | 60 lm           |  |                 |
| QLSP29RDD  | Red   | 50                  | 2.2                | 2.6 | 615~630            | 6000  | 10000           |  |                 |
| QLSP29YDD  | Amber | 50                  | 2.2                | 2.6 | 588~594            | 6000  | 10000           |  |                 |

<sup>\*</sup>Tolerance = +/- 10%

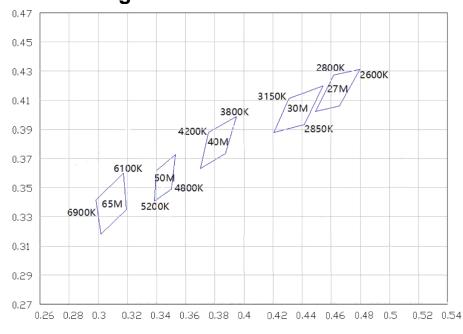
**Absolute Maximum Rating** 

(T=25°C)

| Part #     | P <sub>d</sub> (mW) | I <sub>F</sub> (mA) | I <sub>FP</sub> (mA)* | V <sub>R</sub> (V) | Tj(°C) | TOP (oC) | T <sub>ST</sub> (°C) | T <sub>SOL</sub><br>(°C)** | R <sub>th(J-S)</sub><br>(C/W)*** |
|------------|---------------------|---------------------|-----------------------|--------------------|--------|----------|----------------------|----------------------------|----------------------------------|
| QLSP29WXDH | 450                 | 150                 | 200                   | 5                  | 120    | -40 – 80 | -40 – 85             | 260                        | 20                               |
| QLSP29RDD  | 168                 | 70                  | 90                    | 5                  | 120    | -40 – 80 | -40 – 85             | 260                        | 20                               |
| QLSP29YDD  | 168                 | 70                  | 90                    | 5                  | 120    | -40 – 80 | -40 – 85             | 260                        | 20                               |

<sup>\*</sup>Duty 1/10 @ 10Khz

## ■ White Binning





<sup>\*\*</sup> IR Reflow for no more than 10 sec @ 260 °C

<sup>\*\*\*</sup> Junction to substrate



Dominate Wavelength (nm) Bin:

| Wd (nm) |           |      |      |  |  |
|---------|-----------|------|------|--|--|
| Color   | Code name | Min. | Max. |  |  |
|         | DS2       | 588  | 590  |  |  |
| Amber   | DT1       | 590  | 592  |  |  |
|         | DT2       | 592  | 594  |  |  |
|         | A7        | 615  | 620  |  |  |
| Red     | A8        | 620  | 625  |  |  |
|         | A9        | 625  | 630  |  |  |

Measurement tolerance is +/- 1nm

Forward Voltage (VF) Bin:

| VF Rank (V)    |           |     |      |  |  |  |
|----------------|-----------|-----|------|--|--|--|
| Color          | Code name | Low | High |  |  |  |
|                | 01        | 2.8 | 3.0  |  |  |  |
| White          | 23        | 3.0 | 3.2  |  |  |  |
|                | 45        | 3.2 | 3.4  |  |  |  |
|                | 67        | 3.4 | 3.6  |  |  |  |
|                | PQ        | 1.8 | 2.0  |  |  |  |
| Amber/<br>Red/ | RS        | 2.0 | 2.2  |  |  |  |
|                | TU        | 2.2 | 2.4  |  |  |  |
|                | VW        | 2.4 | 2.6  |  |  |  |

The forward voltage tolerance is  $\pm 0.1 \text{V}$ 

### **Luminous Flux Bin:**

| Rank @0mA (lm) / (mcd) |           |          |           |  |  |  |
|------------------------|-----------|----------|-----------|--|--|--|
| Color                  | Code name | Low      | High      |  |  |  |
| White                  | QRT       | 50 lm    | 70 lm     |  |  |  |
| Amber                  | X65       | 6000 mcd | 12000 mcd |  |  |  |
| Red                    | X65       | 6000 mcd | 12000 mcd |  |  |  |

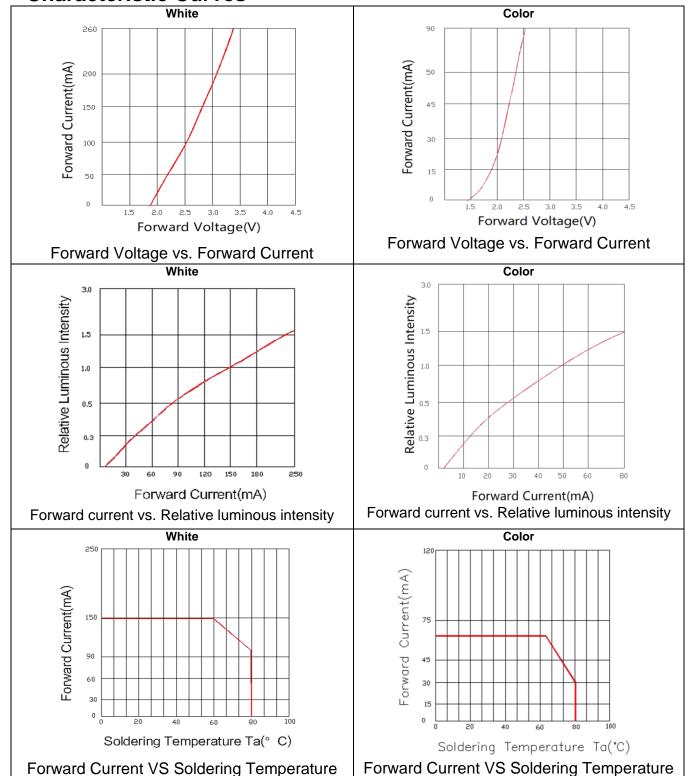
luminous flux tolerance is ± 7%



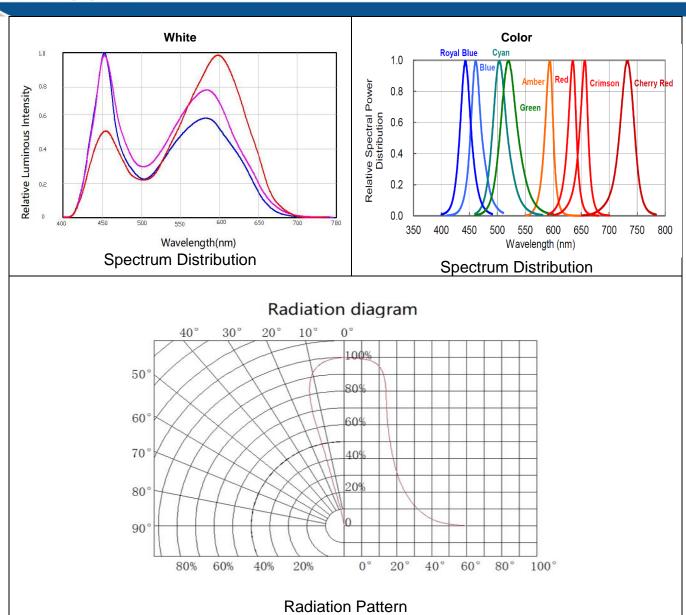


### **Characteristic Curves**

Forward Current VS Soldering Temperature











■ Reliability test:

| No | Item   | Condition   | Time/Cycle | Sample size |
|----|--|---|------------|-------------|
| 1  | Steady State Operating Life of Room Temperature            | 25°C Operating  | 1000 Hrs   | 20 pcs      |
| 2  | Steady State Operating Life of Low Temperature -40°C       | -40°C Operating                                       | 1000 Hrs   | 20 pcs      |
| 3  | Steady State Operating Life of Low Temperature 60°C        | 60°C Operating  | 1000 Hrs   | 20 pcs      |
| 4  | Steady State Operating Life of Low Temperature 85°C        | 85°C Operating  | 1000 Hrs   | 20 pcs      |
| 5  | Low temperature storage -40°C                              | -40°C Storage   | 1000 Hrs   | 20 pcs      |
| 6  | High temperature storage 100℃                              | 100°C Storage   | 1000 Hrs   | 20 pcs      |
| 7  | Steady State Operating Life of High Humidity Heat 60°C 90% | 60°C/90% Operating                                    | 1000 Hrs   | 20 pcs      |
| 8  | Steady State Pulse Operating Life Condition                | 25°ℂ10Hz duty=1/10 Operating                          | 200 Cycle  | 20 pcs      |
| 9  | Resistance to soldering heat on PCB (JEDEC MSL3)           | pre-store@60℃, 60%RH for 52hrs<br>Tsld max.=260 10sec | 3 Times    | 20 pcs      |
| 10 | Heat Cycle Test (JEDEC MRC)                                | 25℃~65℃~-10℃, 90%RH,<br>24hr/1cycle                   | 10 Cycle   | 20 pcs      |
| 11 | Thermal shock  | -40°C/ 20minr~ 5minr~100°C/20min                      | 300 Cycle  | 20 pcs      |

■ Judgment Criteria:

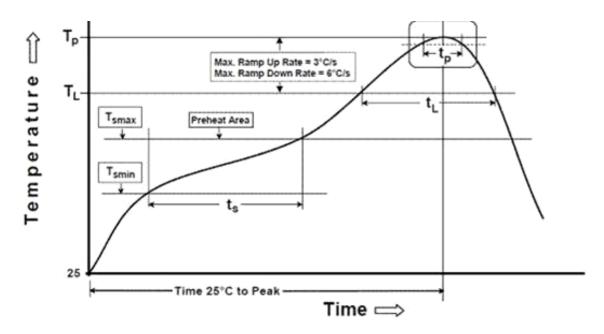
| Item            | Symbol | Test Condition | Judgment<br>Criteria |
|-----------------|--------|----------------|----------------------|
| Forward Voltage | Vf     | 50 mA          | △Vf< 10%             |
| Luminous Flux   | lv     | 50 mA          | △Iv< 30%             |





### **Solder Profile:**

-The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



| Profile Feature  | Sn-Pb Eutectic Assembly | Pb-Free Assembly |
|--|-------------------------|------------------|
| Temperature Min(T <sub>smin</sub> )                                  | 100℃                    | 150℃             |
| Temperature Max(T <sub>smax</sub> )                                  | 150℃                    | 200℃             |
| Time(t <sub>a</sub> ) from (T <sub>smin</sub> to T <sub>smax</sub> ) | 60-120 seconds          | 60-120 seconds   |
| Ramp-up rate( $T_L$ to $T_P$ )                                       | 3℃/second max.          | 3℃/second max.   |
| Liquidous Temperature(T <sub>L</sub> )                               | 183℃                    | 217℃             |
| Time( $t_L$ ) maintained above $T_L$                                 | 60-150 seconds          | 60-150 seconds   |
| Peak package body temperature(T <sub>P</sub> )                       | 235℃                    | 260℃             |
| Time within $5^{\circ}$ of Actual Peak temperature ( $t_p$ )         | 20seconds*              | 30 seconds*      |
| Ramp-down rate( $T_P$ to $T_L$ )                                     | 6℃/second max.          | 6℃/second max.   |
| Time $25^{\circ}$ to peak temperature                                | 6 minutes max.          | 8 minutes max.   |

<sup>\*</sup> Tolerance for peak profile temperature (T<sub>P</sub>) is defined as a supplier minimum and a user maximum.

Note: Number of reflow process shall be less than 1 times





### ■ Notes:

#### **ESD COUNTERMEASURE**

Static electricity and high volt can damage led , The production whose Die material is InGaN must strictly required to prevent ESD , Must put on static glove and static fillet , Soldering tool and the cover of device must connect the ground , soldering condition follows the related stating of production specification manual .

#### PROTECTING COUNTERMEASURE WHEN OVER CURRENT

Need add the protecting resistor in circuit in order to avoid damaging led due to big current and voltage fluctuation •

#### LED INSTALLATION

- (A). Pay attention to the led polarity and avoid installation wrong Led can't be close to euthermic component, work condition should tally with it's specification •
- (B). Don't install the LED under the condition of the led pin deformation •
- (C). The led bracket don't load any pressure when installing the led into PCB or fitting hole  $^{\circ}$
- (D). Must avoid any strike and force on led before the soldering temperature return to room temperature.

#### STORAGE TIME

- (A). Led can be stored for a year under the condition: the temperature of  $5^{\circ}$ C  $\sim 35^{\circ}$ C and humidity of RH60%. These production must be re-inspected and tested before use if their storage time exceed a year.
- (B). If led is exposed in air for a week under the condition: the temperature of  $5^{\circ}$ C ~  $35^{\circ}$ C · humidity of RH60%. must place the led in the ambience of  $65^{\circ}$ C ± $5^{\circ}$ C for 24 hours and use it in 15 days for best.

#### **CLEANING**

Be careful of some chemical results in the led colloid fades and damage when using chemical clean the led such as chloroethylene, acetone etc • can use ethanol to wash or soak led but the time don't exceed 3 minutes.

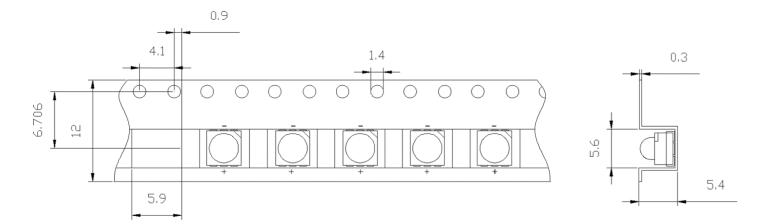
#### **KINKED**

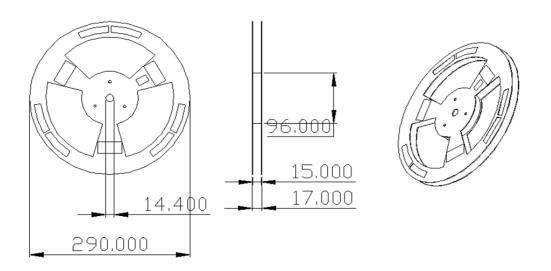
The kinked tooling scrape easliy the pin of led, where the led bracket is rusting easliy, especisal expose it in Moist air. To decrease the led bracket rust, advise using platse tin led bracket





# Taping & Packing:



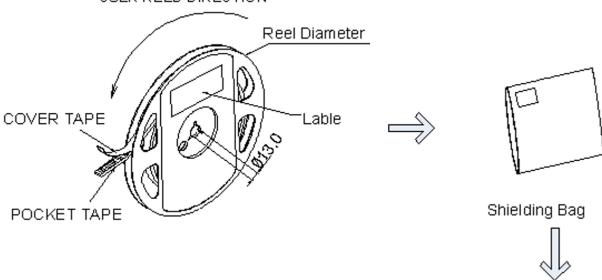


Unit: mm

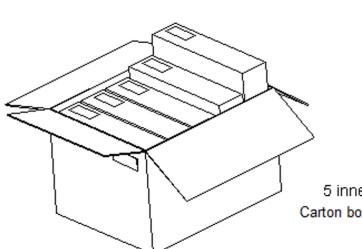


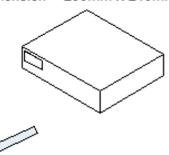


#### USER REED DIRECTION



Maximum 5 bags in 1 inner box Inner box dimension = 290mm x 240mm x 70mm





5 inner box in one carton

Carton box dimension = 390mm x 310mm x 260mm



# Labeling

| Quantity: XXX |  |            | QueLighting     |
|---------------|--|------------|-----------------|
|               |  | Vf Bin: XX | Date Code: XXXX |

Ordering Information:

| Multiple Quantities | Quantity per Reel |
|---------------------|-------------------|
|                     | 1000 pcs          |
|                     |                   |
|                     |                   |
|                     |                   |
|                     |                   |



Revision History:

| Revision Date: | Changes:        | Version #: |
|----------------|-----------------|------------|
| 08-01-2023     | Initial release | 1.0        |
|                |                 |            |
|                |                 |            |
|                |                 |            |
|                |                 |            |

